

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| SADAO OHNO | 01/20/2017 |
| KENGO OSAWA | 01/26/2017 |
| TAKASHI NOZAKI | 01/26/2017 |
| KENICHI TANAKA | 01/20/2017 |
| RECEIVING PARTY DATA | |
| Name: | YOKOWO CO., LTD. |
| Street Address: | 5-11, TAKINOGAWA 7-CHOME |
| City: | KITA-KU, TOKYO |
| State/Country: | JAPAN |
| Postal Code: | 114-8515 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 15504471 |
| CORRESPONDENCE DATA | |
| Fax Number: | (202)739-3001 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 2027393000 |
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| Correspondent Name: | ROBERT J. GAYBRICK |
| Address Line 1: | MORGAN, LEWIS & BOCKIUS LLP |
| Address Line 2: | 1111 PENNSYLVANIA AVENUE, NW |
| Address Line 4: | WASHINGTON, D.C. 20004 |
| ATTORNEY DOCKET NUMBER: | 40894-7914 |
| NAME OF SUBMITTER: | MARY JANE BOSWELL |
| SIGNATURE: | /Mary Jane Boswell/ |
| DATE SIGNED: | 02/16/2017 |
| Total Attachments: 4 | |
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ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

Composite Antenna and Method of Producing the Same

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, **YOKOWO CO., LTD.**, a corporation of Japan, whose post office address is **5-11, Takinogawa 7-chome, Kita-ku, Tokyo 114-8515 Japan**, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

| | | |
|--|---|--------------------------|
| Full Name of Sole or First Assignor Sadao OHNO | Assignor's Signature <i>Sadao Ohno</i> | Date January 20, 2017 |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Second Assignor Kengo OSAWA | Assignor's Signature <i>K. OSAWA</i> | Date January 26, 2017 |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No | | |

| | | |
|--|--|--------------------------|
| Full Name of Third Assignor Takashi NOZAKI | Assignor's Signature | Date |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Fourth Assignor Kenichi TANAKA | Assignor's Signature <i>K. Tanaka</i> | Date January 20, 2019 |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Fifth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Sixth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Seventh Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Eighth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Ninth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Tenth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Eleventh Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | | |

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

Composite Antenna and Method of Producing the Same

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, **YOKOWO CO., LTD.**, a corporation of Japan, whose post office address is **5-11, Takinogawa 7-chome, Kita-ku, Tokyo 114-8515 Japan**, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

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| Full Name of Sole or First Assignor Sadao OHNO | Assignor's Signature | Date |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Second Assignor Kengo OSAWA | Assignor's Signature | Date |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No | | |

| | | |
|--|---|--------------------------|
| Full Name of Third Assignor Takashi NOZAKI | Assignor's Signature <i>Takashi Nozaki</i> | Date January 26, 2017 |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Fourth Assignor Kenichi TANAKA | Assignor's Signature | Date |
| Address c/o YOKOWO CO., LTD., TOMIOKA PLANT, 1112, Kanohara, Tomioka-shi, Gunma 370-2495 Japan | | Citizenship Japan |
| Full Name of Fifth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Sixth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Seventh Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Eighth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Ninth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Tenth Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Full Name of Eleventh Assignor | Assignor's Signature | Date |
| Address | | Citizenship |
| Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | | |

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